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Thermionic Injection Analysis in Germanium Nanowire Schottky Junction FETs by Means of 1D and 3D Extraction Methods

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Schottky barrier field-effect transistors (SBFETS) are a promising family of devices suitable for realizing "Beyond CMOS" paradigms. As the SBFET device operation is strongly dependent on the metal-semiconductor junction properties, it is important to extract and understand the activation energy to inject charge carriers into the semiconductor channel. In this regard, the three-dimensional (3D) thermionic emission (TE) and the one-dimensional (1D) Landauer-Büttiker (LB) theory are among the most sophisticated methods. Here, both methods are used to analyze the charge carrier injection capabilities of Al-Ge-Al nanowire (NW) heterostructure SBFETs. Whereas the 3D TE model underestimates the activation energy E_a in strong accumulation, at the intrinsic off-point, where merely TE contributes to charge carrier transport, both models give reasonable values close to the theoretically expected Schottky barrier height. Analyzing the underlying mathematical models of 3D TE and 1D LB reveals a quadratic and linear increase of TE in dependence on temperature, respectively. Moreover, till now effects on the E_a originating from the 1D nature of the proposed device were rarely investigated in NW transistors. This comparison contributes to a better understanding and the advancement of SBFET devices and circuit technologies.

1 Introduction

Recently, numerous emerging nanoelectronic and quantum applications have been proposed on the base of Schottky barrier (SB) field-effect transistors (SBFETs) comprising axial metalsemiconductor-metal heterostructures.^{1,2} Such devices rely on the potential modulation across the active region and in particular at the metal/semiconductor junctions. In this respect, bottom-up grown semiconductor nanowires (NWs) are a remarkable proto-typing platform inherently providing high surface smoothness, an ultrathin-body as well as quasi-one-dimensional (1D) nature.^{3,4} Aligning a gate stack atop a metal-semiconductor junction allows the filtering of the charge carrier type and modulating the charge carrier concentration in the semiconductor by tuning the energy bands, i.e., bending them down- or upwards.⁵ This enables promising applications from reconfigurable FETs (RFETs),⁶ and source-gated transistors⁷ to surface plasmon detectors^{8,9} and Josephson junction FETs^{10,11}. In this regard, the properties of the metal-semiconductor junctions play a major role in the overall charge transport mechanism. To characterize the underlying mechanism and efficiency of the charge carrier injection, the extraction of the activation energy E_a has proven to be a useful tool. In contrast to the SB height, which merely considers thermionic emission (TE), Ea also takes field emission (FE), into account and considers the entire device transport path. Notably, the SB extraction generally requires ohmic access to the semiconductor region not available in the device types listed above. Recently, all-optical and non-invasive techniques were introduced to investigate thermionic electron injection on exciton formation¹² or by analyzing the transient absorption spectra¹³. Nevertheless, in the scope of device or circuit realizations, E_a plays a crucial role, as it physically describes the required minimum energy to inject a considerable contribution of charge carriers into the semiconductor. In this respect, metal-Ge junctions have shown different Fermi level pinning, depending strongly on the Ge surface states as studied by Nishimura et al.¹⁴ In the latter study, a dedicated SB (via capacitance-voltage and three dimensional (3D) TE models) for electrons was obtained, whereas the barrier for holes is minimal due to the Fermi level pinning being close to the valence band in

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all investigated metal-Ge junctions.¹⁴ In consequence, holes typically experience a more efficient injection in comparison to electrons, resulting in some cases in quasi-ohmic junctions. 15,16 An important application of such transparent junctions in Al-Ge heterojunction devices are superconductor-semiconductor devices, ¹⁷ as, for example, used in Al-Ge-Al heterojunction based Josephson junction FETs^{11,18}. The semiconductor dimensionality has been rarely considered in the characterization of the above-mentioned junctions since most of them deal with bulky materials. However, when dealing with 1D semiconductors, such as Ge NWs, where quasi-ballistic transport is expected, the conventional parameter extraction methods developed for 3D materials need to be revisited in order to adapt them or substitute them for novel methodologies considering more appropriate device physics.¹⁹ In this work, the 3D TE and 1D Landauer-Büttiker (LB) theory are analyzed, compared, and used to extract the activation energy E_a of the charge transport in NW-based Al-Ge-Al SBFETs.

Results and Discussion 2

The investigated SBFET devices are based on nominally undoped Ge NWs grown on a Ge (111) single crystal substrate by the vapor-liquid-solid method using Au catalyst particles and a diphenylgermane precursor for Ge.²⁰ The Ge NWs exhibit a nominal diameter of $d_{\rm NW} = 35 \, \rm nm$, which is close to the Ge exciton Bohr radius $a_{\rm B}^*$ (Ge: 24.3 nm).²¹ Thus, the 1D density of state confinement needs to be considered. The used precursor enables a NW surface termination with phenyl ligands, which leads to a reduction of native Ge-oxide formation and associated, but undesired influences of interface states^{15,20,22} After the growth, the NWs were passivated by a 13.5 nm thick Al₂O₃ shell by atomic layer deposition, which later also acts as the SBFET's gate oxide. In the next step, the passivated NWs were transferred onto a *p*-Si substrate with a 100 nm thick thermally grown SiO₂ layer atop. Afterwards, Al contacts were fabricated to the Ge NWs by using e-beam lithography (EBL), HF etching, Al sputter deposition and lift-off techniques. To obtain the desired metal-semiconductormetal heterostructure, a rapid thermal annealing process at 673 K was applied to initiate the Al-Ge solid-state atomic exchange mechanism, which typically results in abrupt Al-Ge junctions with nominal Ge segment lengths of ≈ 500 nm.^{23,24} In the last step, Ω shaped Ti top-gates, with Au bond pads covering the Ge channel and metal-semiconductor junctions were fabricated by EBL, evaporation, and lift-off techniques. Finally, resulting in the SBFET illustrated in the scanning electron microscopy (SEM) image in Fig. 1a. Additionally, Fig. 1b,c shows a 3D model and an illustration of the obtained material stack, respectively.

Fig. 2a shows transfer characteristics of the considered Al-Ge-Al NW-based SBFET at different V_D biases ranging from 0.1 V to 0.5 V. Note that, throughout this study the back gate voltage V_{BG} is set to 0 V. Analyzing the transfer characteristic reveals the dominant p-type characteristic of Al-Ge-Al SBFETs, which is caused by Fermi level pinning close to the valence band edge of Ge.¹⁴ In consequence, the injection of holes is more efficient due to a much lower SB in comparison to the electron injection.¹⁵ Therefore, an electron on-current I_{on}^n of 1.8 nA (0.05 μ A μ m⁻¹) is given at $V_{\text{TG}} = 5 \text{ V}$ and a hole on-current $I_{\text{on}}^p = 23.7 \mu \text{A} (677 \mu \text{A} \mu \text{m}^{-1})$

as illustrated in the insets of Fig. 2a. Consequently, applying $V_{TG} \gtrsim 3 V$ (at $V_D = 0.5 V$) leads to predominant thermionic emission of electrons over the barrier until the applied V_{TG} bends the potential bands downwards, so that the SB is thin enough to allow tunneling-dominated electron injection into the conduction band $E_{\rm C}$. In contrast, a $V_{\rm TG} \lesssim 3 \,\rm V$ (at $V_{\rm D} = 0.5 \,\rm V$) leads to an upwards bending of the bands. As the SB for holes is already small, i.e., TE dominates for holes, further band bending induces SB thinning, and an enhanced injection of holes is achieved. This behavior is also evidently observable in the linear representation of the output characteristic illustrated in Fig. 2b, which confirms a linear I/V at low $|V_{DS}|$, demonstrating quasi-ohmic contacts.

In terms of charge carrier injection thermal effects need to be considered, which will also build the base for the investigations of the activation energy extraction below. Increasing the temperature leads to a significant increase of charge carriers overcoming the SB due to their thermally increased energy. A simplified schematic of the charge carrier injection mechanisms is discussed later in Fig. 4a, where the different injection mechanisms are further elaborated on.

In a first step the activation energy E_a is investigated by (3D) TE theory, which in general is defined by the model shown in Equ. $(1).^{25}$

$$J_{\rm D} = A^* T^2 \exp\left(-\frac{E_{\rm a}}{k_{\rm B}T}\right) \left[\exp\left(\frac{qV}{k_{\rm B}T}\right) - 1\right],\tag{1}$$

where $J_{\rm D}$ is the total current density in Am⁻² with the NW crosssection area being 1.45×10^{-11} cm², A^* is the effective 3D Richardson constant, T is the corresponding absolute temperature, q is the elementary charge, E_a is the activation energy, k_B is the Boltzmann constant and V is the drain/source potential (here: $V_{\rm D}$). Importantly, in SBFETs, $V_{\rm D}$ as well as $V_{\rm TG}$ directly influence the activation energy necessary to inject charge carriers.⁵ When us-



Fig. 1 (a) Colored SEM image of the proposed Al-Ge-Al NW-based

SBFET. (b) 3D schematic of the NW heterostructure and the device's

 Ω -shaped top-gate architecture. (c) Axial cross-section with respect to the NW of the material stack. Note that dimensions are not in scale.

at $V_{\rm TG} = -5 \,\rm V$, both reported at $V_{\rm D} = 0.5 \,\rm V$. Note that values in brackets are normalized on-state currents to the nominal $d_{\rm NW}$.

This strong gating tunability of 5 orders of magnitude in the

hole dominant regime, considering an off-current $I_{off} = 152 \text{ pA}$,

is achieved by efficient electrostatically tuning the energy bands



Fig. 2 (a) Ambipolar transfer characteristics of a representative SBFET at different bias voltages $V_{\rm D}$ ranging from 0.1 V to 0.5 V. The insets show simplified band diagrams for electron injection (red; positive $V_{\rm TG}$) and hole injection (blue; negative $V_{\rm TG}$). (b) Linear visualization of the output I/V characteristics at different top-gate voltages $V_{\rm TG}$ ranging from 5 V to -5 V. At low $|V_{\rm DS}|$ a linear trend for $V_{\rm TG} < 0$ V is evident, indicating quasi-ohmic junctions for hole injection.

ing Equ. (1) particular boundary conditions with respect to $V_{\rm D}$ need to be considered. First, V_D can merely be investigated in the linear regime of the underlying output I/V characteristics as well as considering $V_{\rm D} > k_{\rm B}T/q$ (> 25 mV at T = 295 K), i.e., ensuring charge carrier injection by TE. Moreover, in an experimental setup, it cannot be differentiated if the injected charge carriers originate from TE and/or FE. Consequently, in strong charge carrier accumulation – induced by strong band bending ($|V_{TG}| >>$) and therefore thinned SBs - FE is the dominant injection mechanism, where TE models fail. With respect to the experimental extraction of E_a , it needs to be considered, that the 3D Richardson constant A^* is unknown. Therefore, E_a is obtained by measuring the output I/V characteristics over a given temperature range (here: T = 295 K to 400 K) (cf. Fig. 3a) to extract V_{TG} -dependent E_a values. Next, an Arrhenius plot (cf. Fig. 3b) is generated, which gives a linear trend with slope $m = -E_a/k_B + qV_D/k_B$. Moreover, considering that the term $\exp[qV_{\rm D}/(k_{\rm B}T)] >> 1$ [cf. Equ. (1)], Equ. (2) is derived and shows the mathematical relation to obtain Fig. 3b.

$$\ln\left(\frac{J_{\rm D}}{T^2}\right) = \left(-\frac{E_{\rm a}}{k_{\rm B}} + \frac{qV_{\rm D}}{k_{\rm B}}\right)\frac{1}{T} + \ln(A^*),\tag{2}$$

which follows a linear 1/T dependence of the left-side term. Finally, Equ. (3) shows the final expression to obtain E_a from the slope *m* extracted from Fig. 3b.

$$E_{\rm a} = qV_{\rm D} - mk_{\rm B} \tag{3}$$

Considering Fig. 3c, for each $V_{\rm D}$ data point, a dedicated $E_{\rm a}$ can be deduced, which allows a linear extrapolation to $V_{\rm D} = 0$ V to extract $E_{\rm a}$ in dependence of $V_{\rm TG}$. Therefore, $E_{\rm a} = -mk_{\rm B}$ holds. Performing the same methodology for $V_{\rm TG} = 5$ V to -5 V in 1 V steps finally results in Fig. 3d, which shows the $V_{\rm TG}$ -dependent $E_{\rm a}$ of the proposed SBFET.

Remarkably, analyzing Fig. 3d negative E_a values are obtained in strong hole accumulation, which further impact the output and Arrhenius plots (cf. Fig. 3a,b). Increasing temperature results in a decrease of the hole current ($V_{TG} = -5 V$), whereas the electron current ($V_{TG} = 5 V$) increases, due to thermally excited charge carriers. This mechanism is also visible in the positive slope m of the Arrhenius plot (cf. Fig. 3b). Consequently, due to the low value obtained for E_a^p , we assume that the channel resistance is the main contributor in limiting the current and that the Al-Ge junctions are transparent for holes.¹⁵ However, at the intrinsic off-point ($V_{TG} \approx 2V$), a value close to the band gap of bulk Ge is reached, where merely TE contributes, demonstrating the suitability of the 3D TE model in this regime. Finally, activation energies E_a and flat band voltages V_{FB} for *n*- and *p*-type conduction are approximated by a linear fit in the linear regime of the V_{TG} -dependent E_a (cf. Fig. 3d). Remarkably, this extrapolation corresponds to the subthreshold operation regime, where TE dominates. It can be assumed that a higher resolution of the $V_{\rm TG}$ step-width would be required for a more accurate estimation. Remarkably, 1D LB also tackles this issue as demonstrated next.



Fig. 3 (a) Temperature-dependent output characteristics in strong electron and hole accumulation at $V_{\rm TG} = 5$ V and -5 V, respectively. (b) Arrhenius plots of the two corresponding points and for selected bias voltages $V_{\rm D}$. The *x*-axis has been multiplied by a factor of 1000 for plotting purposes. (c) Linear fitting of the $V_{\rm D}$ -dependent $E_{\rm a}$ values to $V_{\rm D} = 0$ V at the two selected $V_{\rm TG}$ biases. (d) $V_{\rm TG}$ -dependent $E_{\rm a}$ values with indicated $E_{\rm a}^{\rm n/p}$ and $V_{\rm FB}^{\rm n/p}$ values for electrons and holes.

1D transport at the subthreshold regime in a NW-based SBFET can be described in the context of the LB model²⁶ by considering quasi-ballistic conduction restricted to the first sub-band. Hence, after some approximations involving Boltzmann statistics, the drain current $I_{\rm D}$ in quasi-ballistic SBFETs due to TE reads as^{27,28}

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where $V_{\rm t} = k_{\rm B}T/q$ is the thermal voltage, *h* is the Planck's constant, $n_{\rm g}$ and $n_{\rm d}$ are gate and drain coupling coefficients, respectively, and $E_{\rm a}$ is an effective energy potential barrier over which pure TE is expected corresponding to the activation energy described above. Notice that both $V_{\rm TG}$ and $V_{\rm D}$ dependencies are considered explicitly in $I_{\rm D}$ by the LB model in contrast to TE theory.

Based on Equ. (4), an Arrhenius-like equation can be obtained after some rearrangements such as

$$\ln\left(\frac{I_{\rm D}}{T}\right) \approx \frac{q}{k_{\rm B}T} \left[n_{\rm g} (V_{\rm GS} - V_{\rm FB}) - E_{\rm a} + n_{\rm d} V_{\rm DS} \right],\tag{5}$$

 $E_{\rm a}$ can be extracted by applying the following methodology: btain the experimental transfer device characteristics at dif-It $V_{\rm D}$ and different T, cf., Fig. 4(a); (ii) map an Arrhenius i.e., $\ln(I_D/T)$ vs. 1/T (cf. Fig. 4(b)); (iii) extract the slope i.e., $\alpha = \partial [\ln(I_D/T)]/\partial (1/T)$ for the different V_{TG} and at $V_{\rm DS}$ (cf. Fig. 4); (iv) by obtaining the value of $\alpha|_{V_{\rm DS}\to 0}$ ach V_{TG} an energy function related to the bias and E_{a} is obed, i.e., $E_a = -(k_B\beta)/q$ (cf. Fig. 4(d)); (v) E_a corresponding e energy potential barrier for a specific carrier is obtained $V_{\rm TB}$ corresponding to the $V_{\rm TG}$ where the plot of $-(k_{\rm B}\beta)/q$, at ubthreshold regime, deviates from a linear response (cf. Fig.). The latter deviation is associated with the onset of tunnelnjection and, hence, to a bias region where Equ. (4) is no er valid. A detailed explanation of the extraction method can ound elsewhere^{29,30}. It is worth noticing that by using the acted values, Equ. (4) describes the experimental data (not vn here) with substantial accuracy within the subthreshold ne. Furthermore, both methods can benefit from dedicated structures limiting tunneling injection such as the ones suged elsewhere^{29,30}.

Finally, comparing the E_a results obtained by 3D TE and 1D LB allows to analyze specific differences between the two models. Fig. 5 shows the V_{TG} -dependent E_a data of four devices and their standard deviation. Analyzing these data shows that $E_{\rm a}$ extracted with the 3D TE methodology leads to more negative values in strong accumulation as compared to the E_a extraction with the 1D LB model. In this respect, it needs to be considered that at the interpolation at $V_D = 0$ V, the 1D LB model explicitly takes the electrostatic gating into account, with the slope being $\beta = -(qE_a)/k_B + q/k_B [n_g(V_{TG} - V_{FB})]$, whereas in 3D TE the slope is merely defined by $m = -E_a/k_B$. Hence, leading to a more accurate E_a extraction with the 1D LB model. Additionally, the 1D LB model was verified by numerical device simulations on carbon nanotube FETs and NW FETs, proving its applicability for the extraction of the activation energy.^{29,30} Moreover, it needs to be considered, that the underlying TE model (cf. Equ. 1) is defined assuming the injection from a 3D metal into a 3D semiconductor, whereas in this work, the injection from a metal into a quasi-1D semiconductor (NW) is performed (cf. Fig. 1). Therefore, it is expected that the 1D LB theory delivers more accurate E_a values for quasi-1D NW applications as shown elsewhere where it has



Fig. 4 (a) Temperature dependent transfer characteristics at $V_{\rm D}=0.1\,{\rm V}$. (b) Arrhenius plot required for 1D LBM extraction at $V_{\rm D}=0.1\,{\rm V}$. The *x*-axis has been multiplied by a factor of 1000 for clarity. (c) The slope of Arrhenius plots at different $V_{\rm D}$. (d) Activation energy plot from where the effective SB heights are obtained at $V_{\rm FB}$ with $\beta = n_{\rm g}(V_{\rm TG}-V_{\rm FB})-E_{\rm a}$. (b) and (c) show $V_{\rm TG}$ data corresponding to the *n*- and *p*-type subthreshold regimes.

been compared to results obtained with a different 3D-based extraction methodology.²⁹ Another aspect to consider is the effect of the temperature T in Equ. (2) vs. Equ. (5), where in the 3D TE model the temperature is considered quadratically and in the 1D LB model linearly. Thus, deducing a different TE-related injection tendency of charge carriers over temperature.³⁰ A convenient sanity check of the obtained results is to sum up the extracted n- and p-branch activation energies to verify if the sum equals to the band gap energy of Ge ($E_g = 0.67 \,\text{eV}$). Considering the table illustrated in Fig. 5 with mean values of the investigated devices one can obtain a ΔE of 405 meV and 220 meV for the 3D TE and 1D LB model, respectively; further highlighting the better suitability of the 1D LB model for NW geometries even beyond the quantum confinement limit. Nevertheless, it needs to be considered that E_g of quantum confined NWs exhibit higher values compared to its bulk counterpart.⁴ Remarkably, at the intrinsic off-point an E_a value close to the band gap of Ge is estimated as no electrostatic effects from the gate are considered. Further, confirming the Fermi level pinning close to the valence band. Finally, Tab. 1 shows the detailed extracted values of the investigated devices.

Conclusions

In conclusion, the activation energy E_a of NW-based Al-Ge-Al SBFETs, using 3D TE and 1D LB theory has been investigated. A

Table 1 Extracted parameters of the different devices using the 3D TE model and the 1D LB theory. The notation of the table elements is: TE/LB.

Device	$E_{\rm a}^n({\rm meV})$	$V_{\rm FB}^n({ m V})$	$E^p_{\rm a}({ m meV})$	$V^p_{ m FB}({ m V})$
1	-/283	-/3.9	-/99	-/0.2
2	176/-	5/-	61/-	-1/-
3	198/274	4/3.2	101/90	-1/-0.1
4	208/315	4/3.3	51/287	-1/1.1



Fig. 5 Comparison of the V_{TG} -dependent activation energies E_a extracted by 3D TE (grey) and 1D LB (red) theory. The table shows the extracted mean values of four devices and their standard deviation. The black arrows illustrate the difference between 3D TE and 1D LB at specific points of interest

comparison of the V_{TG} -dependent E_a values of both methods revealed an underestimation of 3D TE in strong accumulation and an overestimation at the intrinsic off-point. Considering the band gap of bulk Ge, a deviation of 405 meV for the 3D TE and 220 meV for the 1D LB model was obtained. Hence, demonstrating a better suitability of the 1D LB theory for the extraction of an injection activation energy for 1D NW-based SBFETs even beyond quantum confinement. The provided comparison contributes to a better understanding of the extraction of activation energies, which is important for SBFET device optimization.

Author contributions

M.S. and R.B. performed the device fabrication. R.B. conducted the measurements. A.P. conducted the 1D LB investigations. R.B. and A.P. wrote the manuscript. S.B. provided the Ge NWs. M.S. and W.M.W. conceived the project and contributed essentially to the experimental design.

Conflicts of interest

There are no conflicts to declare.

Data availability

Data is available on request from the authors. The data that support the findings of this study are available from the corresponding authors upon reasonable request.

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Data is available on request from the authors. The data that support the findings of this study are ware ware available from the corresponding authors upon reasonable request.